ABSTRACT

This project provides development and qualification of Smart Sensors capable of self-diagnosis and assessment of their capability/readiness to support operations. These sensors will provide pressure and temperature measurements for use in ground systems.

Project Technology Maturity

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Technology Area: Ground & Launch Systems Processing TA13 (Primary)
Robotics, Tele-Robotics & Autonomous Systems TA04 (Secondary)

ANTICIPATED BENEFITS

To NASA funded missions:

Ethernet-based temperature and pressure smart multi-sensor arrays capable of self-calibration, self-assessment, automated configuration control and other capabilities will support maintenance “on-need” instead of schedule-based preventive maintenance and will result in improved data reliability and decreased maintenance cost. Supports autonomous operations/systems with self-prognostics/diagnostics capabilities.

Read more on the last page.
DETAILED DESCRIPTION

Intelligent Devices embeds algorithms directly on the sensor, which allows the sensor to reason about its health and readiness to perform an operation. Intelligent Devices and the architecture that supports them allow sensor fusion - that is, taking multiple sensing elements and providing the best health and status, based on all the inputs. This technology is also an enabler for operational capabilities that were not previously possible, including determining the actual configuration of the hardware to providing enhanced fault detection or virtual sensing of things that are derived, such as density from pressure and temperature or rate of change. Not only will Intelligent Devices help to improve system availability; this technology will also allow us to extend recalibration cycles, which translates to a cost savings.
TECHNOLOGY DETAILS

Advanced Ground Systems Maintenance Intelligent Devices/Smart Sensors

TECHNOLOGY DESCRIPTION

Intelligent Devices embeds algorithms directly on the sensor, which allows the sensor to reason about its health and readiness to perform an operation. Intelligent Devices and the architecture that supports them allow sensor fusion - that is, taking multiple sensing elements and providing the best health and status, based on all the inputs. This technology is also an enabler for operational capabilities that were not previously possible, including determining the actual configuration of the hardware to providing enhanced fault detection or virtual sensing of things that are derived, such as density from pressure and temperature or rate of change.

This technology is categorized as a hardware assembly for other applications

- Technology Area
  - TA13 Ground & Launch Systems Processing (Primary)
  - TA04 Robotics, Tele-Robotics & Autonomous Systems (Secondary)
  - TA06 Human Health, Life Support & Habitation Systems (Additional)

CAPABILITIES PROVIDED

Plug-and-play sensor capability: 5 Ethernet-based temperature probes and 5 Ethernet-based pressure heads with smart multi-sensor arrays capable of self-calibration, self-assessment, automated configuration control and other capabilities. Plug-and-play sensor capability.

Intelligent Devices help to improve system availability and allow ground systems maintainers to extend recalibration cycles, which translates to a cost savings.
IMAGE GALLERY

Intelligent Devices undergoing testing